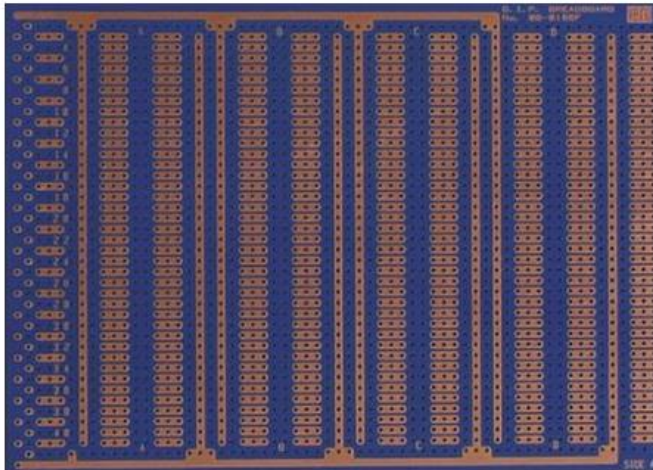


Datasheet

Non-Eurocard Prototyping Board

RS Stock number 159-6192



DIP Breadboard

A range of low density boards for hard wiring of integrated circuits, particularly useful in R & D applications. 0V and VCC rail patterns are duplicated on the component side of the board giving increased power capacity. These boards do not have gold plated contacts, therefore offering a cost saving over plug-in boards. In place of contacts, individual mounting pads for terminal pins are provided.

Features

- Ideal for hard wired applications
- Grid print to aid component layout
- Full range of terminal pins available for interfacing

DIP Breadboard

| Board dims | Rows/Pads | Rows/Pads | Base material |
|-----------------|-----------|-----------|---------------|
| 114,30 x 156,21 | 4/39 | 4/39 | SRBP |

Notes:

7,62 pitch IC DIP 15,24 pitch IC DIP; hole grid 2,54 x 2,54mm hole dia. 1,02mm